

10/31/01
JC961 U.S. PTO

01-02-02

FISH & RICHARDSON P.C.

A
225 Franklin Street
Boston, Massachusetts
02110-2804

Telephone
617 542-5070

Faximile
617 542-8906

Web Site
www.fr.com

J1046 U.S. PTO
10/032941
10/31/01

October 31, 2001

W.K. Richardson
1859-1951

Attorney Docket No.: 13292-007001

Box Patent Application
Commissioner for Patents
Washington, DC 20231

Presented for filing is a new original patent application of:

Applicant: HARRY HEDLER, THORSTEN MEYER AND BARBARA VASQUEZ

Title: COMPLIANT RELIEF WAFER LEVEL PACKAGING

Enclosed are the following papers, including those required to receive a filing date under 37 CFR §1.53(b):

	<u>Pages</u>
Specification	10
Claims	3
Abstract	1
Declaration	2 [unsigned]
Drawing(s)	18

Enclosures:

— Postcard.

Basic filing fee	\$740
Total claims in excess of 20 times \$18	\$54
Independent claims in excess of 3 times \$84	\$0
Fee for multiple dependent claims	\$0
Total filing fee:	\$794

CERTIFICATE OF MAILING BY EXPRESS MAIL

Express Mail Label No. EL694849130US

I hereby certify under 37 CFR §1.10 that this correspondence is being deposited with the United States Postal Service as Express Mail Post Office to Addressee with sufficient postage on the date indicated below and is addressed to the Commissioner for Patents, Washington, D.C. 20231.

October 31, 2001

Date of Deposit

Diane M. Miles

Signature

Diane M. Miles

Typed or Printed Name of Person Signing Certificate

FISH & CHARDSON P.C.

Commissioner for Patents
October 31, 2001
Page 2

A check for the filing fee is enclosed. Please apply any other required fees or any credits to deposit account 06-1050, referencing the attorney docket number shown above.

If this application is found to be incomplete, or if a telephone conference would otherwise be helpful, please call the undersigned at (617) 542-5070.

Kindly acknowledge receipt of this application by returning the enclosed postcard.

Please send all correspondence to:

FRANK R. OCCHIUTI
Fish & Richardson P.C.
225 Franklin Street
Boston, Massachusetts 02110-2804

Respectfully submitted,

Natasha C. Us

Natasha C. Us
Technology Specialist
Reg. No. 44,381

Enclosures

NXU/ava

20338560.doc

APPLICATION
FOR
UNITED STATES LETTERS PATENT

TITLE: COMPLIANT RELIEF WAFER LEVEL PACKAGING
APPLICANT: HARRY HEDLER, THORSTEN MEYER AND BARBARA VASQUEZ

CERTIFICATE OF MAILING BY EXPRESS MAIL

Express Mail Label No. EL694849130US

I hereby certify under 37 CFR §1.10 that this correspondence is being deposited with the United States Postal Service as Express Mail Post Office to Addressee with sufficient postage on the date indicated below and is addressed to the Commissioner for Patents, Washington, D.C. 20231.

October 31, 2001

Date of Deposit

Diane M. Miles

Signature

Diane M. Miles

Typed or Printed Name of Person Signing Certificate